### 2mm x 5mm BI-COLOR RECTANGULAR LED LAMP

Part Number: L-117GYWT

Green Yellow

### • Uniform light output.

**Features** 

- Suitable for level indicator.
- Low power consumption.
- Long life solid state reliability.
- RoHS compliant.

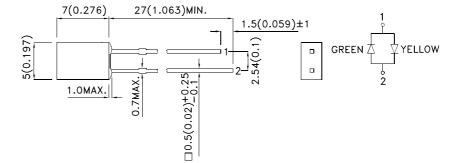
#### Description

The Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.







Notes:

1. All dimensions are in millimeters (inches).

2. Tolerance is ±0.25(0.01") unless otherwise noted.

Lead spacing is measured where the lead emerge from the package.
The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

DATE: MAY/09/2013 DRAWN: Q.M.Chen



#### **Selection Guide** Iv (mcd) [2] Viewing @ 20mA Angle [1] Part No. Dice Lens Type Min. 201/2 Тур. 2 6 Green (GaP) L-117GYWT 110° White Diffused Yellow (GaAsP/GaP) 2 4

Notes:

1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Luminous intensity/ luminous Flux: +/-15%.
Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green Yellow	565 590		nm	l⊧=20mA
λD [1]	Dominant Wavelength	Green Yellow	568 588		nm	l⊧=20mA
Δλ1/2	Spectral Line Half-width	Green Yellow	30 35	2	nm	I⊧=20mA
С	Capacitance	Green Yellow	15 20		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green Yellow	2.2 2.1	2.5 2.5	V	l⊧=20mA

Notes:

1.Wavelength: +/-1nm.

Forward Voltage: +/-0.1V.
Wavelength value is traceable to the CIE127-2007 compliant national standards.

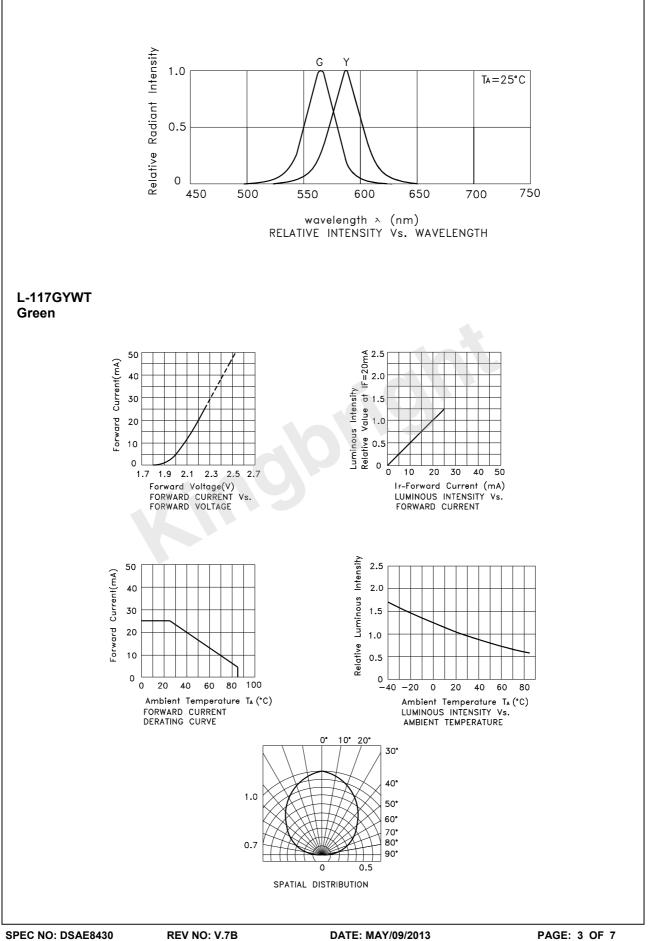
### Absolute Maximum Ratings at TA=25°C

Parameter	Green	Yellow	Units		
Power dissipation	62.5	75	mW		
DC Forward Current	25	30	mA		
Peak Forward Current [1]	140	140	mA		
Operating / Storage Temperature	-40°C To +85°C				
Lead Solder Temperature [2]	Solder Temperature [2] 260°C For 3 Seconds				
Lead Solder Temperature [3]	260°C For 5 Seconds				

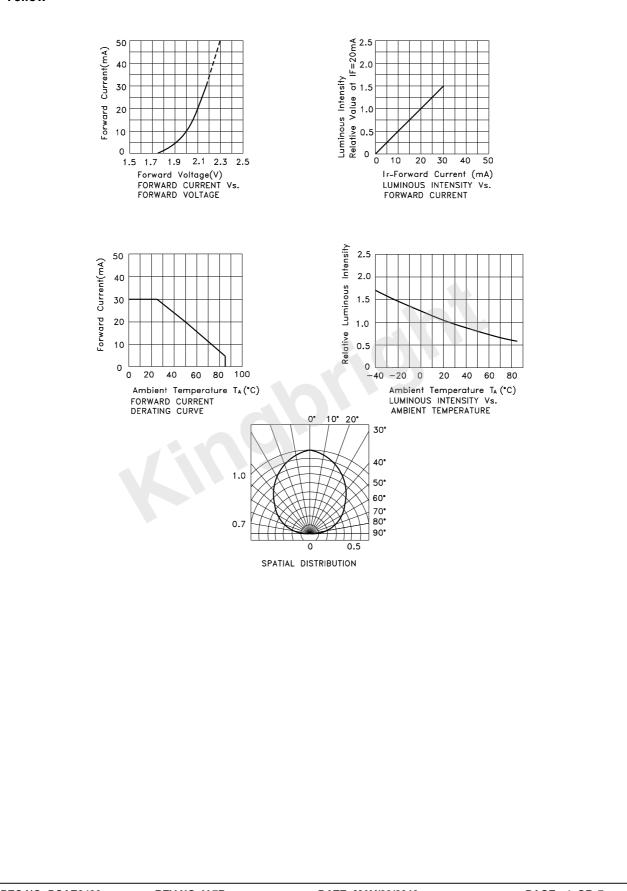
Notes:

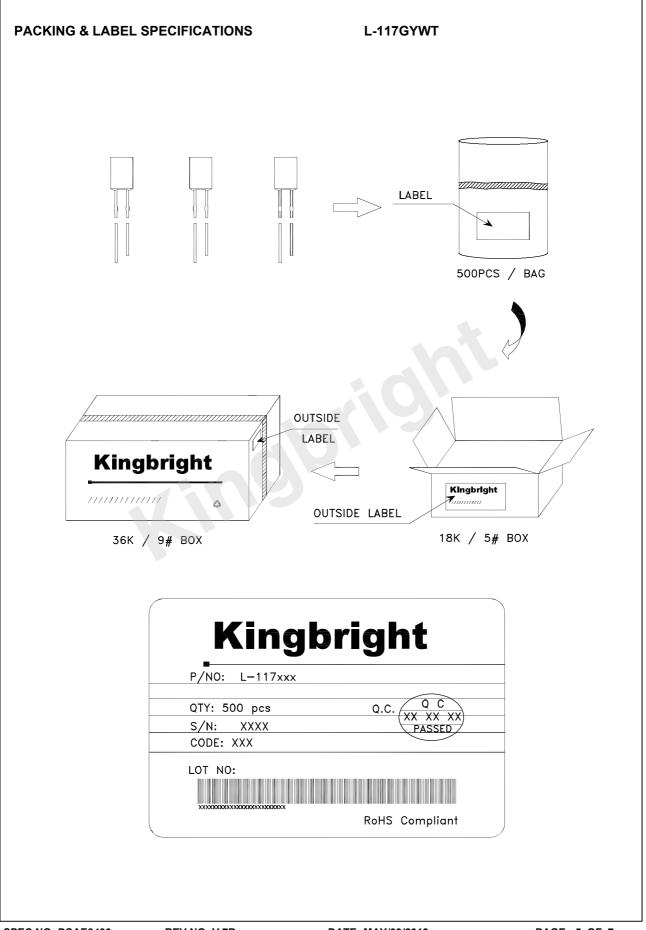
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.

3. 5mm below package base.



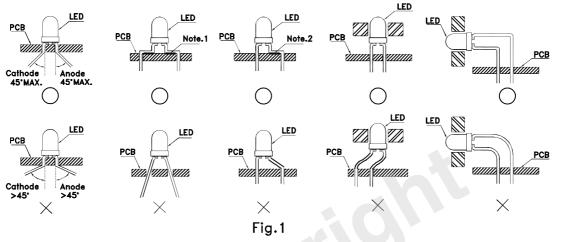
Yellow





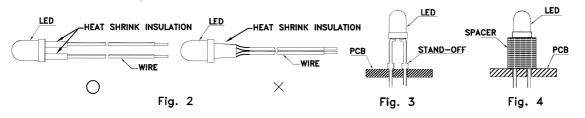
### PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)

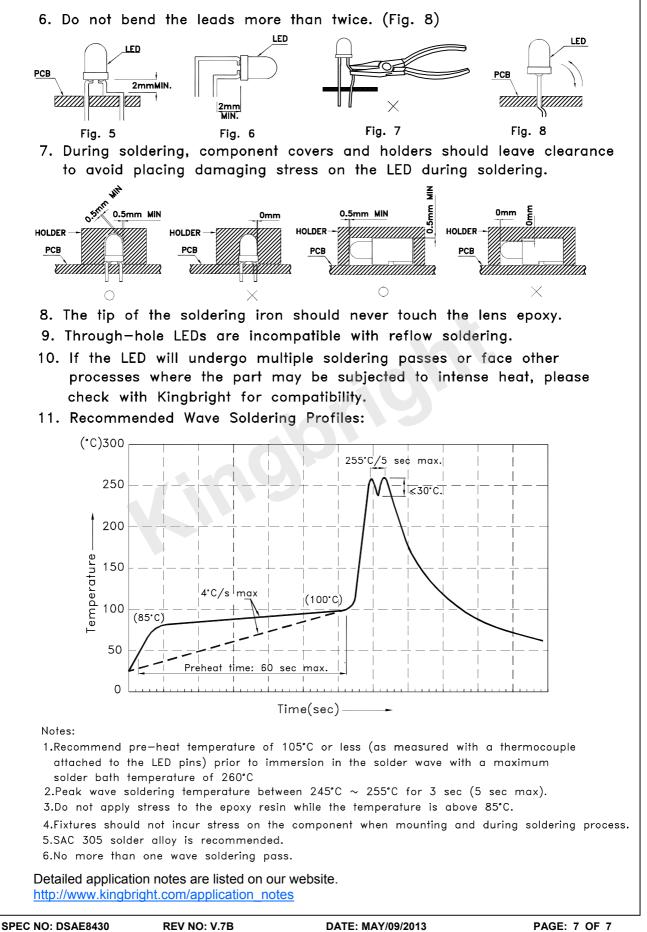


" $\bigcirc$ " Correct mounting method "imes" Incorrect mounting method

- 2. When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit. (Fig.2)
- 3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



- 4. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)



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